

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER
Features

- Guard Ring Die Construction for Transient Protection
- Low Leakage Current
- Low Forward Voltage Drop
- **Lead Free By Design/RoHS Compliant (Note 3)**
- **"Green Device" (Note 4)**

Mechanical Data

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish — Matte Tin Finish annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.01 grams (approximate)



Top View

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Forward Current (See Figure 1)	I _{F(AV)}	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	16	A
Repetitive Peak Reverse Current t _p = 2μs square wave, f = 1KHz	I _{RRM}	0.5	A
Non-Repetitive Peak Reverse Current t _p = 100μs square wave	I _{RSM}	1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2) (Note 5)	P _D	350 410	mW
Typical Thermal Resistance Junction to Ambient (Note 2) (Note 5)	R _{θJA}	304 251	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _(BR)	40	—	—	V	I _R = 40μA
Forward Voltage	V _F	—	0.52 0.48	0.55 0.51	V	I _F = 1A, T _J = 25°C I _F = 1A, T _J = 100°C
Leakage Current (Note 1)	I _R	—	—	10 40 5	μA μA mA	V _R = 5V, T _J = 25°C V _R = 40V, T _J = 25°C V _R = 40V, T _A = 100°C

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
 2. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 3. No purposefully added lead.
 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 5. Part mounted on polyimide board with pad sizes 0.24" x 0.16".
 6. Part mounting such that R_{θJA} = 175°C/W.

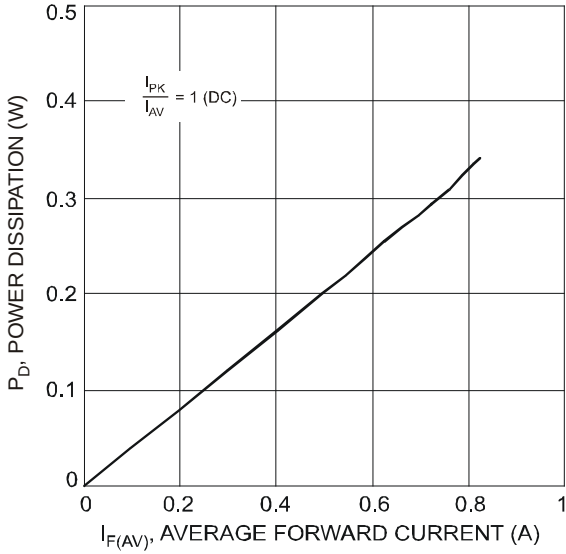


Fig. 1 Forward Power Dissipation

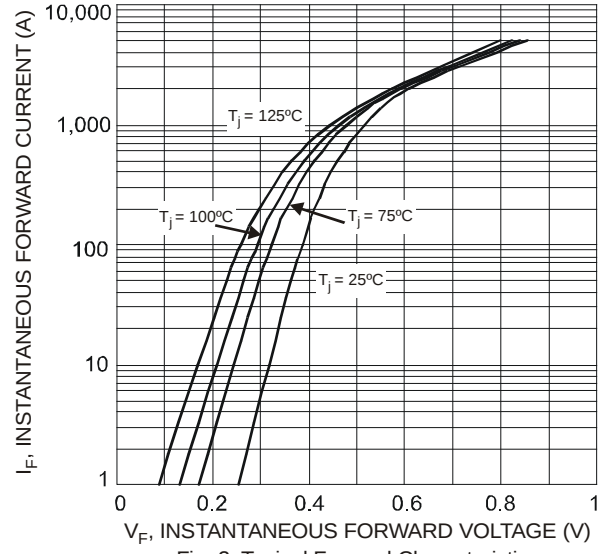


Fig. 2 Typical Forward Characteristics

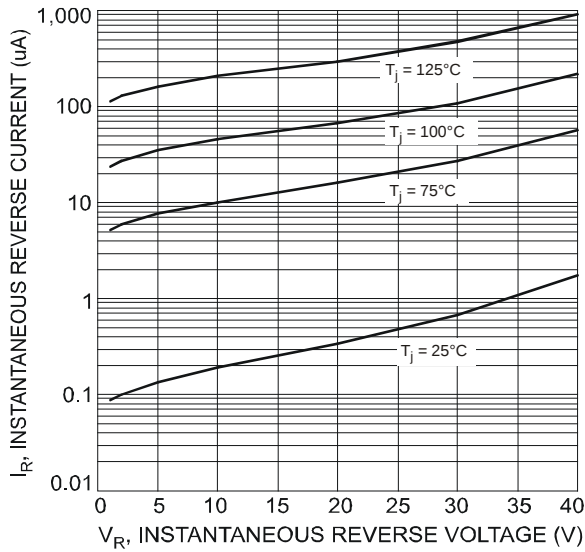


Fig. 3 Typical Reverse Characteristics

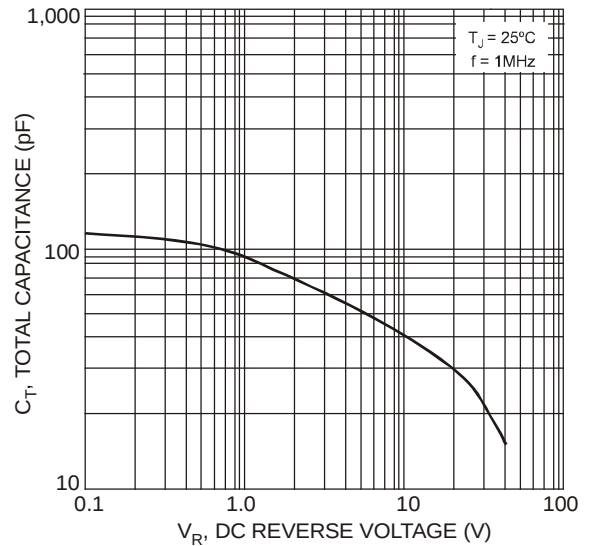


Fig. 4 Total Capacitance vs. Reverse Voltage

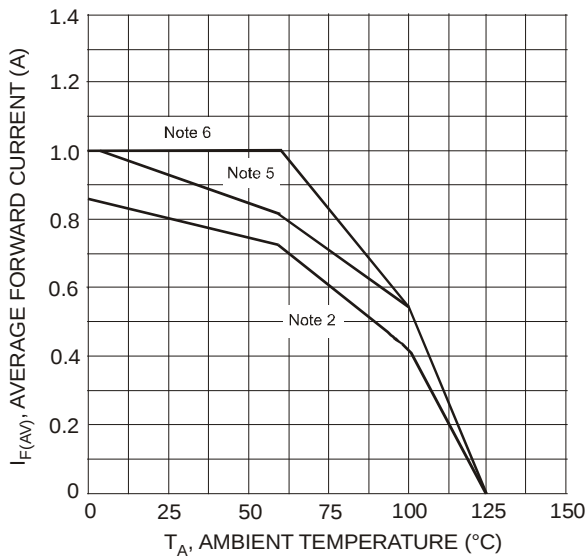


Fig. 5 Forward Current Derating Curve

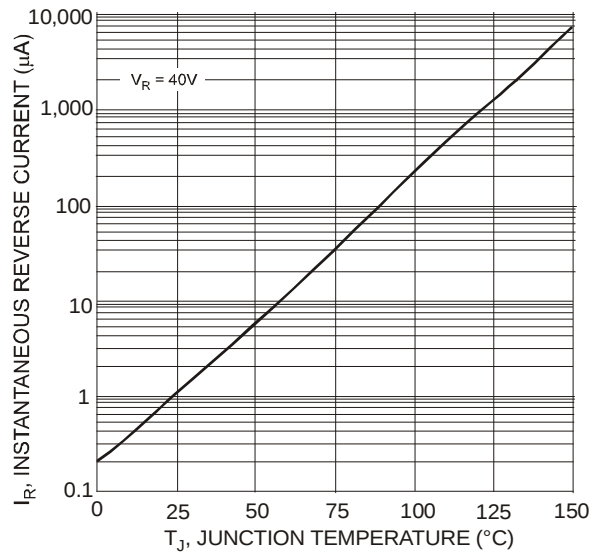


Fig. 6 Typical Reverse Current vs. Junction Temperature

Ordering Information (Note 7)

Part Number	Case	Packaging
B140HW-7	SOD-123	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



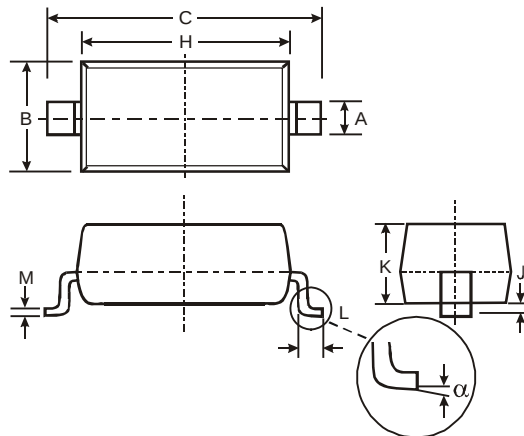
LO = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: S = 2005)
 M = Month (ex: 9 = September)

Date Code Key

Year	2005	2006	2007	2008	2009	2010	2011	2012
Code	S	T	U	V	W	X	Y	Z

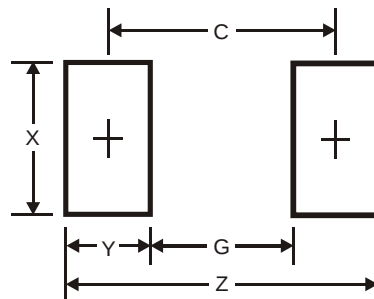
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SOD-123		
Dim	Min	Max
A	0.55 Typ	
B	1.40	1.70
C	3.55	3.85
H	2.55	2.85
J	0.00	0.10
K	1.00	1.35
L	0.25	0.40
M	0.10	0.15
α	0	8°
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	4.9
G	2.5
X	0.7
Y	1.2
C	3.7

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